

Boston, Massachusetts 02209

Docket No. 60437 (70820)

DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that: My residence, post office address and citizenship are as stated below next to my name. I believe I am the original, first and sole inventor (if only one name is listed at 201) below or an original, first and joint inventor (if plural names are listed at 201-206 below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

POWER TRANSISTOR AND SEMICONDUCTOR INTEGRATED CIRCUIT USING THE SAME

which is described and claimed in:

[]	the specification attached hereto.
^ [:	-	the specification in U.S. Application Serial Number 10/735,399 , filed on the specification in U.S. Application Serial Number 11, 2003.
[]	3	the specification in PCT international application Number,
filed on		; and was amended on

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a). I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

Prior Foreign/PCT Applications and Any Priority Claims Under 35 U.S.C. §119:					
Application No.	Filing Date	Country	Priority Claimed Under 35 U.S.C. §119?		
2002-359117	December 11, 2002	Japan	[x] YES [] NO		
2003-404517	December 3, 2003	Japan	[x]YES [] NO		
			[]YES[]NO		

I hereby claim the benefit under 35 U.S.C. §120 of any United States application(s) or PCT international application(s) designating the United States of America that is/are listed below, and, insofar as the subject matter of each of the claims of this application is not disclosed in that/those prior application(s) in the manner provided by the first paragraph of 35 U.S.C. §112, I acknowledge the duty to disclose material information as defined in 37 CFR §1.56(a) which occurred between the filing date of the prior application(s) and the national or PCT international filing date of this application:

U.S. Applications				Status (Check One)		
Application	ı Serial No.	U.S. Filing Date	Patented	Pending	Abandoned	
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PCT A	Applications Des	ignating the U.S.	·			
Application No.	Filing Date	U.S. Serial No. Assigned				
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	the benefit under	OF PRIOR U.S. PROVISIO (35 U.S.C. §119(e)) Title 35, United States Code, §	•		•	
Applicant		Provisional Application Numb	oer	Filing Date		
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David G. Conlin George W. Neuner Linda M. Buckley Peter F. Corless Peter J. Manus Cara Z. Lowen William J. Daley, Jr Robert L. Buchanan	(Reg. No. 27,026) (Reg. No. 26,964) (Reg. No. 31,003) (Reg. No. 33,860) (Reg. No. 26,766) (Reg. No. 38,227) (Reg. No. 35,487) (Reg. No. 40,927)	Christine C. O'Day Lisa Swiszcz Hazzard David A. Tucker George W. Hartnell, III John B. Alexander Steven M. Jensen Kathryn A. Piffat Richard J. Roos	(Reg. No. 38,256) (Reg. No. 44,368) (Reg. No. 27,840) (Reg. No. 42,639) (Reg. No. 48,399) (Reg. No. 42,693) (Reg. No. 34,901) (Reg. No. 45,053)	Dianne M. Rees	(Reg. No. 32,264) (Reg. No. 45,281) (Reg. No. 50,927) (Reg. No. 36,984) (Reg. No. 32,138) naclas (46,608)
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SEND CORRESPONDENCE TO:	DIRECT TELEPHONE CALLS TO:
Dike, Bronstein, Roberts & Cushman Intellectual Property Practice Group Edwards & Angell, LLP P. O. Box 9169 Boston, Massachusetts 02209	(617) 439-4444

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<u> </u>	FULL NAME OF	I ACT NAME	FIRST NAME	MIDDLE NAME
	INVENTOR	LASI KAME		
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<u>L</u>	<u> </u>			LACONI VILLAGO
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I hereby further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further, that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Signature of Inventor 201	Signature of Inventor 202
Terujuki Maeda	
Date: 2004, 1, 6	Date:
Signature of Inventor 203	Signature of Inventor 204
Date:	Date:
Signature of Inventor 205	Signature of Inventor 206
Date:	Date:

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